



Small Signal Switching Diode

Features

- Silicon Planar Diode
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC





Applications

• General purpose

Mechanical Data

Case: MiniMELF Glass case (SOD80)

Weight: approx. 31 mg
Cathode Band Color: Black
Packaging Codes/Options:

GS18/10 k per 13" reel (8 mm tape), 10 k/box GS08/2.5 k per 7" reel (8 mm tape), 12.5 k/box



Parts Table

Part	Ordering code	Type Marking	Remarks
BA604	BA604-GS18 or BA604-GS08	-	Tape and Reel

Absolute Maximum Ratings

T_{amb} = 25 °C, unless otherwise specified

amb :				
Parameter	Test condition	Symbol	Value	Unit
Peak reverse voltage, non repetitive		V _{RSM}	80	V
Reverse voltage		V _R	50	V
Peak forward surge current	t _p = 1 μs	I _{FSM}	2	Α
Repetitive peak forward current		I _{FRM}	450	mA
Forward continuous current		I _F	200	mA
Power dissipation		P _V	500	mW

Thermal Characteristics

T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Thermal resistance junction to ambient air on PC board 50 mm x 50 mm x 1.6 mm		R _{thJA}	500	K/W
Junction lead	T _L = constant	R_{thJL}	350	K/W
Junction temperature		Tj	175	°C
Storage temperature range		T _{stg}	- 55 to + 175	°C

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Rev. 1.7, 26-Jul-06

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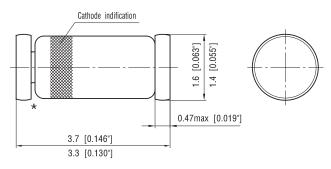


Electrical Characteristics

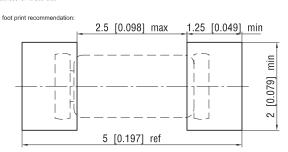
 T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Min	Тур.	Max	Unit
Forward voltage	I _F = 50 mA	V _F			1100	mV
Reverse current	V _R = 50 V	I _R			1	μΑ
	V _R = 20 V	I _R			50	nA
	$V_R = 20 \text{ V}, T_j = 150 ^{\circ}\text{C}$	I _R			50	μΑ
Breakdown voltage	I _R = 100 μA	V _(BR)	80			V
Reverse recovery time	$I_F = 10 \text{ mA}, I_R = 10 \text{ mA},$ $I_R = 1 \text{ mA}$	t _{rr}			20	ns
Diode capacitance	V _R = 0, f = 1 MHz	C _D			4	pF

Package Dimensions in mm (Inches): SOD80



★ The gap between plug and glass can be either on cathode or anode side



Document no.:6.560-5005.01-4 Rev. 8 - Date: 07.June.2006 96 12070



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Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

> We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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Document Number 85528 www.vishay.com Rev. 1.7, 26-Jul-06



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Revision: 18-Jul-08

Document Number: 91000 www.vishay.com